



PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

December 16, 2009

Applicants: Masashi KUMAGAI et al

For: COPPER ELECTROLYTIC SOLUTION AND
ELECTROLYTIC COPPER FOIL PRODUCED THEREWITH

Serial No.: 10/531 645

Group: 1795

Confirmation No.: 1483

Filed: April 15, 2005

Examiner: Mendez

International Application No.: PCT/JP2003/013044

International Filing Date: October 10, 2003

Atty. Docket No.: 4700.P0312US

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

APPELLANTS' BRIEF ON APPEAL

Sir:

This is an appeal from the decision of the Examiner dated July 23, 2009, finally rejecting Claims 4-8.

REAL PARTY IN INTEREST

Nikko Materials Co., Ltd. is the assignee of the present application and the real party in interest.

RELATED APPEALS AND INTERFERENCES

There are no related appeals and interferences to the present application.

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STATUS OF CLAIMS 01 FC:1402

540.00 OP

Claims 1-3 have been canceled. Claims 4-8 are pending and are the claims under consideration on appeal.